

Electronic Patent Application Fee Transmittal

Application Number:	10822522			
Filing Date:	12-Apr-2004			
Title of Invention:	Method and system for communicating semiconductor manufacturing information to customers			
First Named Inventor/Applicant Name:	Hui-Jye Hshieh			
Filer:	Liem T. Do/Bonnie Boyle			
Attorney Docket Number:	24061.123 (TSMC2003-0744)			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Independent claims in excess of 3	1201	1	200	200
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				200